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**UNITED STATES  
SECURITIES AND EXCHANGE COMMISSION**  
Washington, D.C. 20549

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**FORM 8-K**

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**CURRENT REPORT**  
Pursuant to Section 13 or 15(d)  
of the Securities Exchange Act of 1934

**Date of Report (Date of earliest event reported): July 21, 2017**

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**Applied Materials, Inc.**  
(Exact name of registrant as specified in its charter)

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**Delaware**  
(State or other jurisdiction  
of incorporation)

**000-06920**  
(Commission  
File Number)

**94-1655526**  
(IRS Employer  
Identification No.)

**3050 Bowers Avenue**  
**P.O. Box 58039**  
**Santa Clara, CA**  
(Address of principal executive offices)

**95052-8039**  
(Zip Code)

**Registrant's telephone number, including area code: (408) 727-5555**

**N/A**  
(Former name or former address, if changed since last report.)

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Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions:

- Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
- Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4(c))

Indicate by check mark whether the registrant is an emerging growth company as defined in Rule 405 of the Securities Act of 1933 (§230.405 of this chapter) or Rule 12b-2 of the Securities Exchange Act of 1934 (§240.12b-2 of this chapter).

Emerging growth company

If an emerging growth company, indicate by check mark if the registrant has elected not to use the extended transition period for complying with any new or revised financial accounting standards provided pursuant to Section 13(a) of the Exchange Act.

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**Item 5.02 Departure of Directors or Certain Officers; Election of Directors; Appointment of Certain Officers; Compensatory Arrangements of Certain Officers.**

On July 21, 2017, the Board of Directors (the "Board") of Applied Materials, Inc. (the "Company") appointed Daniel J. Dum, age 50, Chief Financial Officer, effective on or about August 24, 2017, following the filing of the Company's Quarterly Report on Form 10-Q for the third quarter of fiscal 2017. Mr. Dum will join the Company as Senior Vice President on August 7, 2017 and will succeed our current Chief Financial Officer, Robert J. Halliday. Mr. Halliday will remain with the Company to support a smooth transition and move to a new role focused on business development.

Mr. Dum is currently Executive Vice President and Chief Financial Officer of NXP Semiconductors N.V., a semiconductor manufacturer ("NXP"). Mr. Dum joined NXP in 2015, having served as Senior Vice President of Finance and Chief Financial Officer of Freescale Semiconductor, Inc., from June 2014 until its merger with NXP in December 2015. Prior to Freescale, Mr. Dum was Chief Financial Officer and Executive Vice President of Finance and Administration at GlobalFoundries, a semiconductor foundry, which he joined in December 2011.

Mr. Dum's offer letter with the Company, dated July 21, 2017, provides that Mr. Dum will initially receive an annual base salary of \$600,000 and will be eligible to earn a target bonus of 110% of his base salary under the Company's Senior Executive Bonus Plan ("SEBP") beginning in fiscal year 2018. Actual bonus earned, if any, will be subject to the terms of the SEBP and based on achievement of performance goals established by the Human Resources and Compensation Committee (the "HRCC") of the Board. Because Mr. Dum's employment with the Company occurs after the eligibility date for a 2017 SEBP bonus award, he will earn a special bonus payment of \$250,000 six months following his start date, subject to active employment as of such date. Mr. Dum will also receive a sign-on bonus payment of \$500,000 ("Sign-On Bonus") after 30 days of continuous employment with the Company. In the event that Mr. Dum resigns or the Company terminates his employment for cause prior to the completion of 24 months of service, Mr. Dum will be obligated to repay the Company for the full amount of the Sign-On Bonus, less any amounts withheld by the Company for taxes.

In addition, following completion of 30 days of continuous employment with the Company, Mr. Dum will be awarded the following equity awards: (1) new hire restricted stock units ("RSUs") with a value of \$2,500,000, scheduled to vest ratably over three years beginning on February 1, 2018, and subject to acceleration of vesting in the event that the Company terminates Mr. Dum without cause before February 1, 2020; (2) long-term incentive award with a target value of \$1,500,000, consisting of performance shares ("PSUs"), scheduled to vest in December 2019, subject to achievement of certain performance targets established by the HRCC relating to the Company's three-year average wafer fabrication equipment ("WFE") market share and the Company's three-year average non-GAAP adjusted operating margin; and (3) long-term incentive award with a value of \$1,500,000, consisting of RSUs scheduled to vest in three equal installments on each of January 15, 2018, December 19, 2018 and December 19, 2019. In each case, the number of RSUs or PSUs granted will be determined by dividing the stated value of the award by the closing price of the Company's stock on the date of grant. Mr. Dum will also receive relocation benefits under the Company's standard relocation policy.

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The Company issued a press release on July 24, 2017 announcing the appointment of Mr. Dum, which is attached as Exhibit 99.1 to this report.

**Item 9.01 Financial Statements and Exhibits.**

(d) Exhibits

<u>Exhibit No.</u>	<u>Description</u>
99.1	Press Release issued by Applied Materials, Inc. dated July 24, 2017

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**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

Applied Materials, Inc.  
(Registrant)

Dated: July 24, 2017

By: /s/ Thomas F. Larkins  
Thomas F. Larkins  
Senior Vice President, General Counsel  
and Corporate Secretary

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**EXHIBIT INDEX**

<u>Exhibit No.</u>	<u>Description</u>
99.1	Press Release issued by Applied Materials, Inc. dated July 24, 2017



## NEWS RELEASE

### Applied Materials Announces Dan Durn to be Next Chief Financial Officer

- Semiconductor industry veteran will join Applied Materials in August
- Bob Halliday to remain with the company, moving to new role focused on business development

SANTA CLARA, Calif., July 24, 2017 – Applied Materials, Inc. today announced that Dan Dum will join the company as senior vice president on August 7, 2017 and assume the role of chief financial officer on August 24. Mr. Dum, 50, is currently CFO of NXP Semiconductors N.V. Bob Halliday, 63, will remain with the company to support a smooth transition and move to a new role focused on business development. Mr. Halliday is planning to retire towards the end of 2018.

“Dan brings a tremendous combination of experience and knowledge that can help accelerate Applied’s strategy,” said Gary Dickerson, president and CEO. “These are exciting times as our markets are strong and getting stronger, Applied is better positioned than ever before and we have a great platform to drive sustainable profitable growth. Bob has done a terrific job as CFO and I’m confident that Dan is going to step in and help us reach new heights.”

“I am very excited to be joining Applied Materials, a company that has terrific capabilities and is working in the sweet spot of the industry,” said Dan Dum. “I have a great deal of respect for Gary, Bob and the Applied leadership team, and I’m confident that we are going to do great things together. I can’t wait to get started.”

Mr. Dum joined NXP in 2015, having served as CFO of Freescale up until the merger with NXP. Prior to Freescale, he was CFO and executive vice president of finance and administration at GLOBALFOUNDRIES. Previously, he was head of M&A and strategy at Advanced Technology Investment Company (ATIC), a \$15 billion private equity company, and he also served as vice president in technology investment banking at Goldman, Sachs & Company and was a member of its merger leadership group. Mr. Dum received an MBA in finance from Columbia Business School and graduated from the U.S. Naval Academy with a BS in control systems engineering.

### Webcast and Conference Call Information

Applied Materials will discuss this announcement during a webcast that begins at 8:45 a.m. EDT / 5:45 a.m. PDT today. The live webcast will be available on Applied Materials’ website at: <http://www.appliedmaterials.com/investor-relations>. The live conference call phone number is 1-855-546-9563 (toll free) or 1-412-455-6135 (international) with passcode 60282748. Participants should dial in 15 minutes before the call to allow time to be connected by the operator. Replays of the webcast will be available beginning at 12:00 p.m. EDT / 9:00 a.m. PDT on July 24 and will remain available for at least 30 days.

### Forward-Looking Statements

This press release contains forward-looking statements, including those regarding anticipated growth in our markets and business, and other statements that are not historical facts. These statements and their underlying assumptions are subject to risks and uncertainties and are not guarantees of future performance. Factors that could cause actual results to differ materially from those expressed or implied by such statements include, without limitation: our ability to expand our current markets, increase market share and develop new markets; market acceptance of existing and newly developed products; and other risks and uncertainties described in our most recent Form 10-Q and other filings with the SEC. All forward-looking statements are based on management’s current estimates, projections and assumptions, and we assume no obligation to update them.

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July 24, 2017

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**About Applied Materials**

Applied Materials, Inc. (Nasdaq: AMAT) is the leader in materials engineering solutions used to produce virtually every new chip and advanced display in the world. Our expertise in modifying materials at atomic levels and on an industrial scale enables customers to transform possibilities into reality. At Applied Materials, our innovations make possible the technology shaping the future. Learn more at [www.appliedmaterials.com](http://www.appliedmaterials.com).

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